

TC55329AP/AJ-15/20/25/35

SILICON GATE CMOS

32,768 WORD x 9 BIT CMOS STATIC RAM

Description

The TC55329AP/AJ is a 294,912 bit high speed CMOS static random access memory organized as 32,768 words by 9 bits and operated from a single 5V supply. Toshiba's advanced CMOS technology and circuit design enable high speed operation.

The TC55329AP/AJ features low power dissipation when the device is deselected using chip enable ($\overline{CE1}$, $\overline{CE2}$) and has an output enable input (\overline{OE}) for fast memory access. Also, the device power between memory accesses is reduced by an automatic power down circuit.

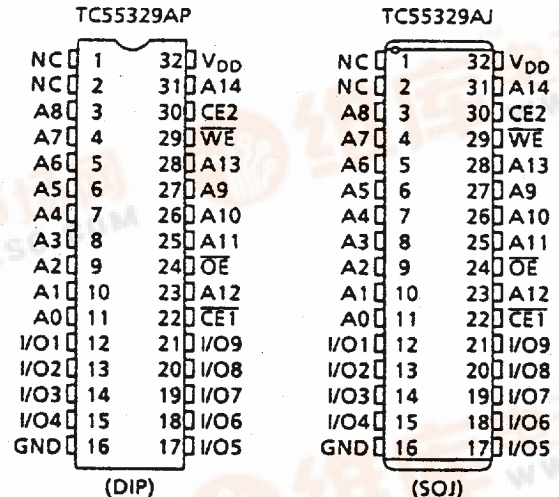
The TC55329AP/AJ is suitable for use in high speed applications such as cache memory and high speed storage. All inputs and outputs are TTL compatible.

The TC55329AP/AJ is available in a 300mil width, 32-pin DIP and SOJ suitable for high density surface assembly.

Features

- Fast access time
 - TC55329AP/AJ-15 15ns (max.)
 - TC55329AP/AJ-20 20ns (max.)
 - TC55329AP/AJ-25 25ns (max.)
 - TC55329AP/AJ-35 35ns (max.)
- Low power dissipation
 - Operation:
 - TC55329AP/AJ-15 140mA (max.)
 - TC55329AP/AJ-20 140mA (max.)
 - TC55329AP/AJ-25 140mA (max.)
 - TC55329AP/AJ-35 120mA (max.)
 - Standby: 1mA (max.)
- Single 5V power supply: $5V \pm 10\%$
- Fully static operation
- Inputs and outputs TTL compatible
- Output buffer control: \overline{OE}
- Package:
 - TC55329AP: DIP32-P-300
 - TC55329AJ: SOJ32-P-300

Pin Connection (Top View)



Pin Names

A0 ~ A14	Address Inputs
I/O1 ~ I/O9	Data Inputs/Outputs
$\overline{CE1}$, $\overline{CE2}$	Chip Enable Inputs
\overline{WE}	Write Enable Input
\overline{OE}	Output Enable Input
V _{DD}	Power (+5V)
GND	Ground
NC	No Connection

[illegible]

MODE \ PIN	$\overline{CE1}$	CE2	\overline{OE}	\overline{WE}	I/O1 ~ I/O9	POWER
Read	L	H	L	H	Output	I _{DDO}
Write	L	H	*	L	Input	I _{DDO}
Output Disable	L	H	H	H	High Impedance	I _{DDO}
Standby	H	*	*	*	High Impedance	I _{DDs}
	*	L	*	*	High Impedance	I _{DDs}

*H or L

SYMBOL	ITEM	RATING	UNIT
V _{DD}	Power Supply Voltage	-0.5 ~ 7.0	V
V _{IN}	Input Voltage	-2.0 ~ 7.0	V
V _{I/O}	Input/Output Voltage	-0.5* ~ V _{DD} + 0.5	V
P _D	Power Dissipation	1.0	W
T _{SOLDER}	Soldering Temperature • Time	260 • 10	°C • sec
T _{STRG}	Storage Temperature	-65 ~ 150	°C
T _{OPR}	Operating Temperature	-10 ~ 85	°C

*-3V with a pulse width of 10ns

DC Recommended Operating Conditions

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V_{DD}	Power Supply Voltage	4.5	5.0	5.5	V
V_{IH}	Input High Voltage	2.2	—	$V_{DD} + 0.5$	V
V_{IL}	Input Low Voltage	-0.5*	—	0.8	V

* -3V with a pulse width of 10ns

DC Characteristics ($T_a = 0 \sim 70^\circ\text{C}$, $V_{DD} = 5V \pm 10\%$)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
I _{LI}	Input Leakage Current	V _{IN} = 0 ~ V _{DD}	—	—	±1	μA	
I _{LO}	Output Leakage Current	CE1 = V _{IH} or CE2 = V _{IL} or OE = V _{IH} or WE = V _{IL} , V _{OUT} = 0 ~ V _{DD}	—	—	±1	μA	
I _{OH}	Output High Current	V _{OH} = 2.4V	-4	—	—	mA	
I _{OL}	Output Low Current	V _{OL} = 0.4V	8	—	—	mA	
I _{DDO}	Operating Current	t _{cycle} = Min cycle CE1 = V _{IL} or CE2 = V _{IH} Other Inputs = V _{IH} /V _{IL}	-15	—	—	140	mA
			-20	—	—	140	
			-25	—	—	140	
			-35	—	—	120	
I _{BDS1}	Standby Current	t _{cycle} = Min cycle CE1 = V _{IH} or CE2 = V _{IL} Other Inputs = V _{IH} /V _{IL}	-15	—	—	20	mA
			-20				
			-25				
			-35				
I _{BDS2}		CE1 = V _{DD} - 0.2V or CE2 = 0.2V Other Inputs = V _{DD} - 0.2V or 0.2V	—	—	1		

Capacitance* ($T_a = 25^\circ\text{C}$, $f = 1.0\text{MHz}$)

SYMBOL	PARAMETER	TEST CONDITION	MAX.	UNIT
C_{IN}	Input Capacitance	$V_{IN} = \text{GND}$	6	pF
$C_{I/O}$	Input/Output Capacitance	$V_{I/O} = \text{GND}$	8	pF

*This parameter is periodically sampled and is not 100% tested.

AC Characteristics (Ta = 0 ~ 70°C⁽¹⁾, V_{DD} = 5V±10%)

Read Cycle

SYMBOL	PARAMETER	TC55329AP/AJ-15		TC55329AP/AJ-20		TC55329AP/AJ-25		TC55329AP/AJ-35		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
t _{RC}	Read Cycle Time	15	—	20	—	25	—	35	—	ns
t _{ACC}	Address Access Time	—	15	—	20	—	25	—	35	
t _{CO1}	$\overline{\text{CE1}}$ Access Time	—	15	—	20	—	25	—	35	
t _{CO2}	CE2 Access Time	—	15	—	20	—	25	—	35	
t _{OE}	$\overline{\text{OE}}$ Access Time	—	8	—	10	—	12	—	15	
t _{OH}	Output Data Hold Time from Address Change	5	—	5	—	5	—	5	—	
t _{COE}	Output Enable Time from $\overline{\text{CE1}}$ or CE2	5	—	5	—	5	—	5	—	
t _{COD}	Output Disable Time from $\overline{\text{CE1}}$ or CE2	—	8	—	8	—	10	—	15	
t _{OEE}	Output Enable Time from $\overline{\text{OE}}$	1	—	1	—	1	—	1	—	
t _{ODO}	Output Disable Time from $\overline{\text{OE}}$	—	8	—	8	—	10	—	15	

Write Cycle

SYMBOL	PARAMETER	TC55329AP/AJ-15		TC55329AP/AJ-20		TC55329AP/AJ-25		TC55329AP/AJ-35		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
t _{WC}	Write Cycle Time	15	—	20	—	25	—	35	—	ns
t _{WP}	Write Pulse Width	10	—	11	—	13	—	18	—	
t _{AW}	Address Valid to End of Write	12	—	13	—	15	—	20	—	
t _{CW}	Chip Enable to End of Write	12	—	13	—	15	—	20	—	
t _{AS}	Address Setup Time	0	—	0	—	0	—	0	—	
t _{WR}	Write Recovery Time	0	—	0	—	0	—	0	—	
t _{DS}	Data Setup Time	8	—	10	—	12	—	15	—	
t _{DH}	Data Hold Time	0	—	0	—	0	—	0	—	
t _{OE_W}	Output Enable Time from $\overline{\text{WE}}$	1	—	1	—	1	—	1	—	
t _{ODW}	Output Disable Time from $\overline{\text{WE}}$	—	8	—	8	—	10	—	15	

AC Test Conditions

Input Pulse Levels	3.0V/0.0V
Input Pulse Rise and Fall Time	3ns
Input Timing Measurement Reference Levels	2.2V/0.8V
Output Timing Measurement Reference Levels	2.0V/0.8V
Output Load	Fig. 1

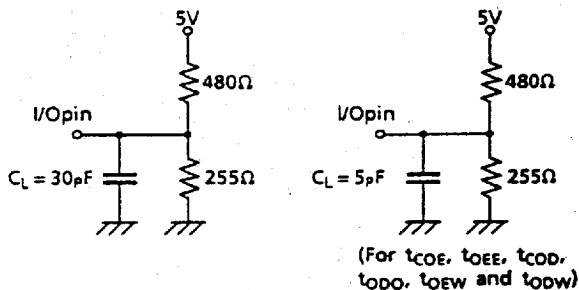
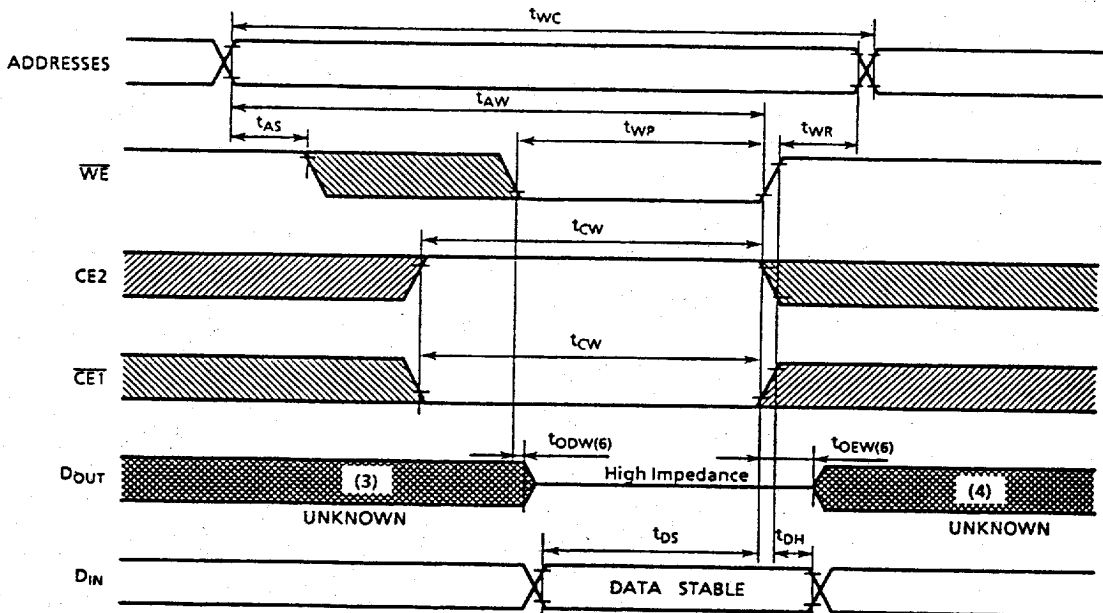
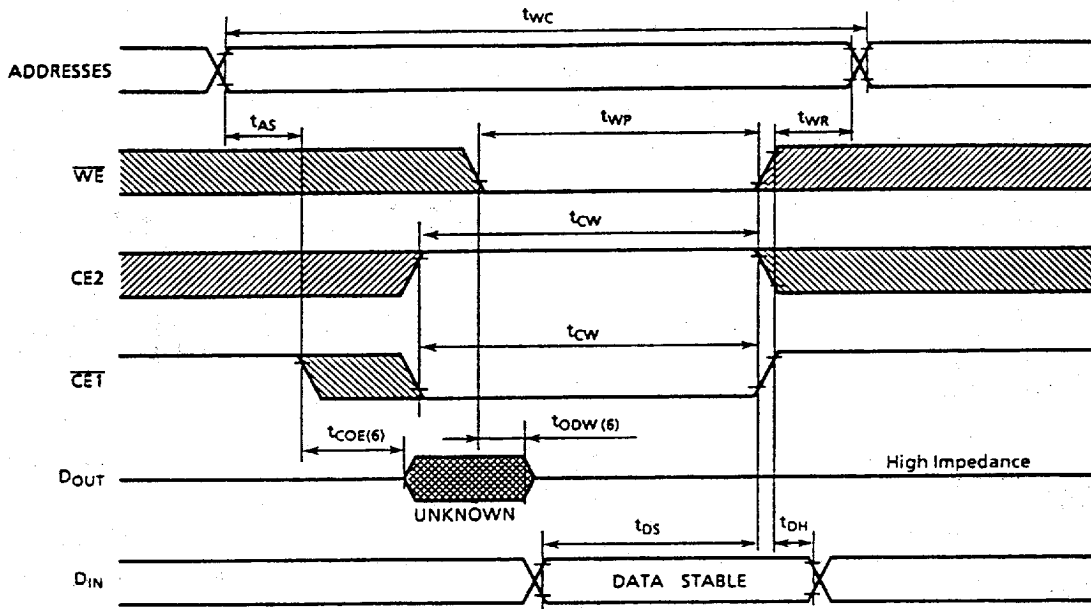
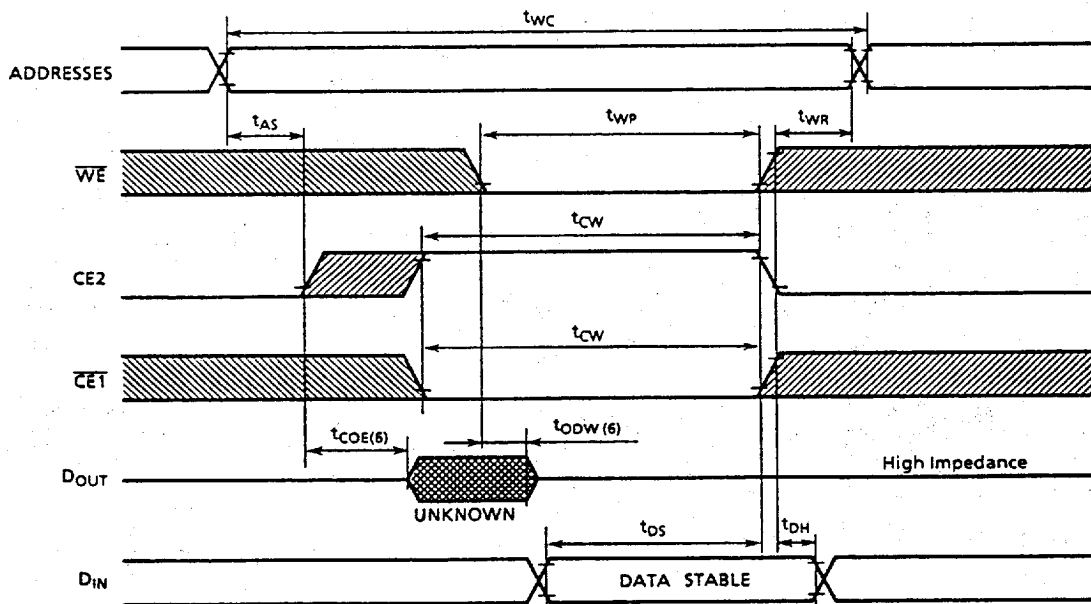


Figure 1.

Read Cycle (2)



Write Cycle 2 ⁽⁵⁾ ($\overline{\text{CE1}}$ Controlled Write)Write Cycle 3 ⁽⁵⁾ (CE2 Controlled Write)

Notes:

1. The operating temperature (T_a) is guaranteed with transverse air flow exceeding 400 linear feet per minute.
2. \overline{WE} is high for read cycles.
3. If the $\overline{CE1}$ low transition or $CE2$ high transition occurs coincident with or after the \overline{WE} low transition, outputs remain in a high impedance state.
4. If the $\overline{CE1}$ high transition or $CE2$ low transition occurs coincident with or prior to the \overline{WE} high transition, outputs remain in a high impedance state.
5. If \overline{OE} is high during a write cycle, the outputs are in a high impedance state during this period.
6. The following parameters are measured using the load shown in Fig. 1.
 - (A) t_{COE} , t_{OEE} , $t_{OE\overline{W}}$ Output Enable Time
 - (B) t_{COD} , t_{ODO} , $t_{OD\overline{W}}$ Output Disable Time

